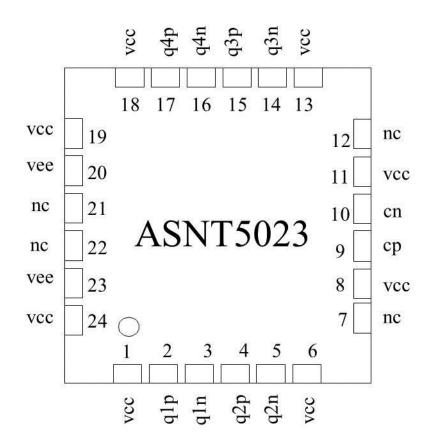


Ultra High-Speed Mixed Signal ASICs

Offices: 310-530-9400 / Fax: 310-530-9402 www.adsantec.com

ASNT5023-PQC DC-28*Gbps*/17*GHz* Signal Distributor 1-to-4

- High-speed broadband Data/Clock Amplifier and Distributor
- Exhibits low jitter and limited temperature variation over industrial temperature range
- One differential input signal port and four differential amplified output signal ports
- Matched phase delays for all outputs
- Fully differential CML input interface
- Fully differential CML output interfaces with 600mV single-ended swing
- Linearized output buffers for minimized undershoot/overshoot
- Single +3.3V or -3.3V power supply
- Nominal power consumption: 1.22*W*
- Fabricated in SiGe for high performance, yield, and reliability
- Standard MLF/QFN 24-pin package





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DESCRIPTION

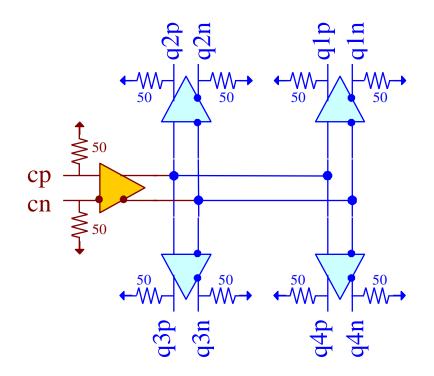


Fig. 1. Functional Block Diagram

The temperature stable ASNT5023-PQC SiGe IC provides active broadband data/clock signal splitting and is intended for use in high-speed measurement / test equipment. The IC shown in Fig. 1 can deliver four phase-matched copies of the broadband data/clock input signal cp/cn to four high-speed differential outputs q1p/q1n, q2p/q2n, q3p/q3n, q4p/q4n.

The part's I/O's support the CML logic interface with on chip 50*Ohm* termination to **vcc** and may be used differentially, AC/DC coupled, single-ended, or in any combination (see also POWER SUPPLY CONFIGURATION). In the DC-coupling mode, the input signal's common mode voltage should comply with the specifications shown in ELECTRICAL CHARACTERISTICS. In the AC-coupling mode, the input termination provides the required common mode voltage automatically. The differential DC signaling mode is recommended for optimal performance.

POWER SUPPLY CONFIGURATION

The part can operate with either negative supply (vcc = 0.0V = ground and vee = -3.3V), or positive supply (vcc = +3.3V and vee = 0.0V = ground). In case of the positive supply, all I/Os need AC termination when connected to any devices with 50*Ohm* termination to ground. Different PCB layouts will be needed for each different power supply combination.

All the characteristics detailed below assume vcc = 0.0V and vee = -3.3V.

Rev. 2.2.2



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ABSOLUTE MAXIMUM RATINGS

Caution: Exceeding the absolute maximum ratings shown in Table 1 may cause damage to this product and/or lead to reduced reliability. Functional performance is specified over the recommended operating conditions for power supply and temperature only. AC and DC device characteristics at or beyond the absolute maximum ratings are not assumed or implied. All min and max voltage limits are referenced to ground.

Parameter	Min	Max	Units
Supply Voltage (vee)		-3.6	V
Power Consumption		1.36	W
RF Input Voltage Swing (SE)		1.4	V
Case Temperature		+90	°С
Storage Temperature	-40	+100	°С
Operational Humidity	10	98	%
Storage Humidity	10	98	%

Table 1. Absolute Maximum Ratings

TERMINAL FUNCTIONS

TERMINAL			DESCRIPTION				
Name	No.	Туре					
High-Speed I/Os							
ср	9	CML	Differentia	al high speed data/clock inputs with internal SE 500hm			
cn	10	input	terminatio	n to VCC			
q1p	2	CML	Differentia	al high speed data/clock outputs with internal SE 500hm			
q1n	3	output	terminatio	n to vcc. Require external SE 500hm termination to vcc			
q2p	4	CML	Differentia	al high speed data/clock outputs with internal SE 500hm			
q2n	5	output	termination	n to vcc. Require external SE 500hm termination to vcc			
q3p	15	CML	Differentia	al high speed data/clock outputs with internal SE 500hm			
q3n	14	output	termination	n to vcc. Require external SE 500hm termination to vcc			
q4p	17	CML	Differentia	al high speed data/clock outputs with internal SE 500hm			
q4n	16	output	termination	n to vcc. Require external SE 500hm termination to vcc			
Supply and Termination Voltages							
Name	Description			Pin Number			
vcc	Positive power supply		r supply	1, 6, 8, 11, 13, 18, 19, 24			
	(+3.3V or 0)		: 0)				
vee	Negative power supply		er supply	20, 23			
	(0V or -3.3V)		3V)				
nc	Not connected pins		ed pins	7, 12, 21, 22			



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ELECTRICAL CHARACTERISTICS

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS		
General Parameters							
vee	-3.1	-3.3	-3.5	V	$\pm 6\%$		
VCC		0.0		V	External ground		
Ivee		370		mА			
Power consumption		1220		mW			
Junction temperature	-40	25	125	°C			
HS data/clock input (cp/cn)							
Data rate	DC		28	Gbps			
Frequency	DC		17	GHz			
Swing	50	300	600	mV	Differential or SE, p-p		
Common mode level	VCC -0.6	VCC -0.5	VCC	mV	Must match for both inputs		
Duty cycle	40	50	60	%	For clock signal		
HS data/clock output (q1p/q1n, q2p/q2n, q3p/q3n, q4p/q4n)							
Data rate	DC		28	Gbps			
Frequency	DC		17	GHz			
Latency		100		ps	From any input to any output		
Phase mismatch			2	ps	Between any two SE outputs		
Logic "1" level		vcc-0.1		V			
Logic "0" level		vcc-0.7		V	With external 500hm DC termination		
Rise/Fall Times	15		19	ps	20%-80%		
Additive Jitter			5	ps	Peak-to-peak		

PACKAGE INFORMATION

The chip die is housed in a standard 24-pin QFN package shown in Fig. 2. It is recommended that the center heat slug located on the back side of the package is soldered to the **vee** plain that is ground for the positive supply or power for the negative supply.

The part's identification label is ASNT5023-PQC. The first 8 characters of the name before the dash identify the bare die including general circuit family, fabrication technology, specific circuit type, and part version while the 3 characters after the dash represent the package's manufacturer, type, and pin out count.

This device complies with Commission Delegated Directive (EU) 2015/863 of 4 June 2015 amending Annex II to Directive 2011/65/EU of the European Parliament and of the Council as regards the list of restricted substances (Text with EEA relevance) on the restriction of the use of certain hazardous substances in electrical and electronics equipment (RoHS Directive) in accordance with the definitions set forth in the directives for all ten substances.





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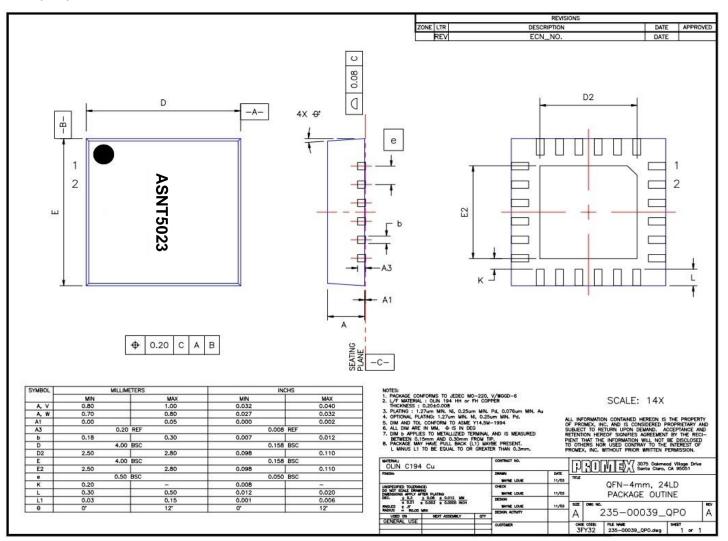


Fig. 2. QFN 24-Pin Package Drawing (All Dimensions in mm)



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REVISION HISTORY

Revision	Date	Changes		
2.2.2	09-2021	Corrected the Absolute Maximum Ratings information		
		Updated RoHS statement in the Package Information section		
2.1.2	02-2020	Updated Package Information		
2.0.2	07-2019	Corrected output logic levels		
1.9.2	07-2019	Updated Letterhead		
1.9.1	08-2018	Corrected latency specifications		
1.8.1	08-2018	Added latency specifications		
1.7.1	05-2013	Corrected supply current and power		
1.6.1	03-2013	Added phase mismatch specifications		
		Updated description		
1.5.1	02-2013	Revised title		
		Revised pin out diagram		
		Revised description		
		Revised power supply configuration		
		Corrected absolute maximum ratings table		
		Corrected terminal functions table		
		Corrected electrical characteristics table		
		Updated package information		
1.4	05-2012	Corrected parameters		
1.3	02-2012	Modified description		
		Modified title		
		Added maximum ratings table		
		Added packaging information		
		Added revision history table		
1.2	01-2012	Modified title and description		
1.0	11-2011	Initial release		